

Features

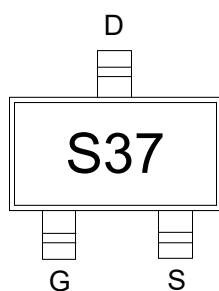
- Trench Power LV MOSFET technology
- High Density Cell Design for Low $R_{DS(ON)}$
- High Speed switching

Product Summary

V_{DS}	$R_{DS(ON)}$ TYP	I_D
-80V	216mΩ@-10V	-2.2A
	242mΩ@-6V	

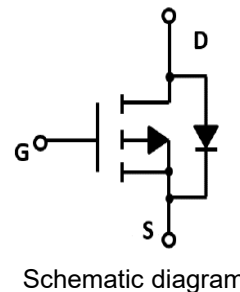
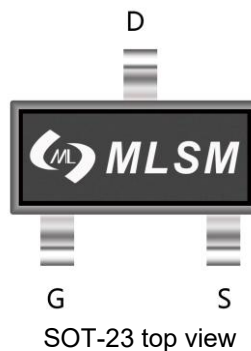
Application

- Battery protection
- Load switch
- Power management



S37: Device code

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings ($T_C=25^{\circ}\text{C}$ Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	-80	V
V_{GS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}\text{C}$
I_S	Diode Continuous Forward Current	$T_C=25^{\circ}\text{C}$ -2.2	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_C=25^{\circ}\text{C}$ -7	A
I_D	Continuous Drain Current	$T_C=25^{\circ}\text{C}$ -2.2	A
P_D	Maximum Power Dissipation	$T_C=25^{\circ}\text{C}$ 2.5	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient	166	$^{\circ}\text{C/W}$

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLS2337	SOT-23	S37	3,000	45,000	180,000	7" reel

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
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Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-80	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-80V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-2	--	-4	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-1.2A	--	216	270	mΩ
		V _{GS} =-6V, I _D =-1.1A	--	242	303	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =-40V, V _{GS} =0V, f=1MHz	--	500	--	pF
C _{OSS}	Output Capacitance		--	40	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	25	--	pF

Switching Characteristics

Q _g	Total Gate Charge	V _{DS} =-40V, I _D =-1.2A, V _{GS} =-6V	--	7	--	nC
Q _{gs}	Gate Source Charge		--	2.1	--	nC
Q _{gd}	Gate Drain Charge		--	3.2	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-40V, I _D =-0.96A, V _{GS} =-10V, R _G =1Ω	--	10	--	nS
t _r	Turn-on Rise Time		--	15	--	nS
t _{d(off)}	Turn-Off Delay Time		--	20	--	nS
t _f	Turn-Off Fall Time		--	15	--	nS

Source- Drain Diode Characteristics

V _{SD}	Forward on voltage	T _J =25°C, I _S =-2.2A	--	--	-1.2	V
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Typical Operating Characteristics

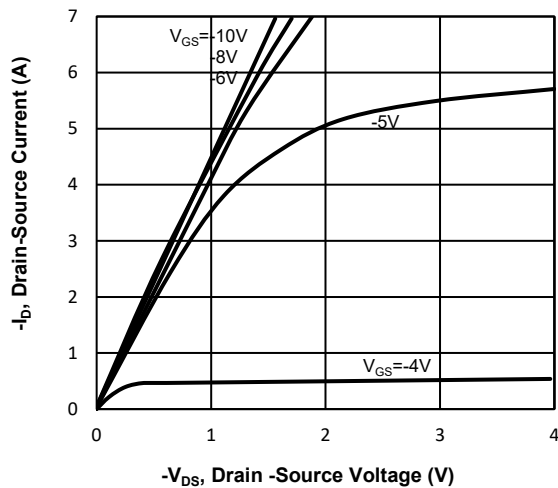


Fig1. Typical Output Characteristics

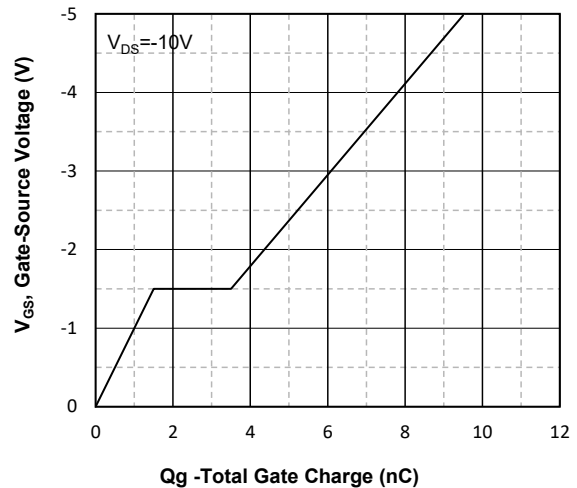


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

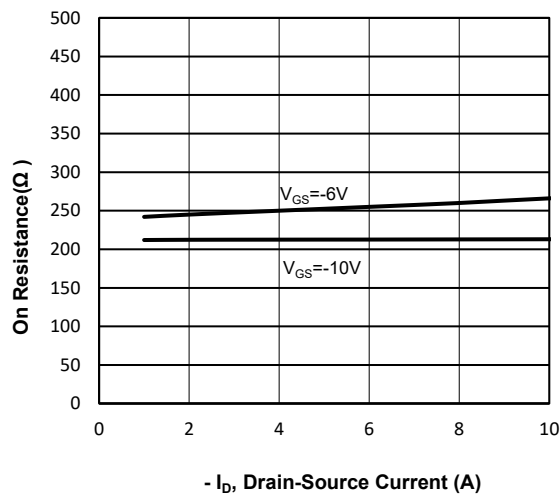


Fig3. Drain-Source on Resistance

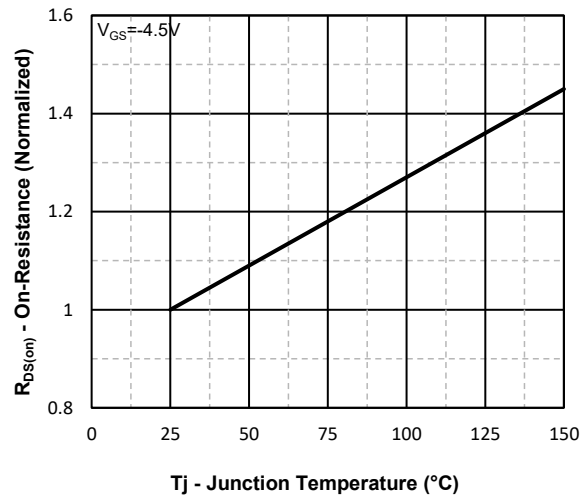


Fig4. Normalized On-Resistance Vs. Temperature

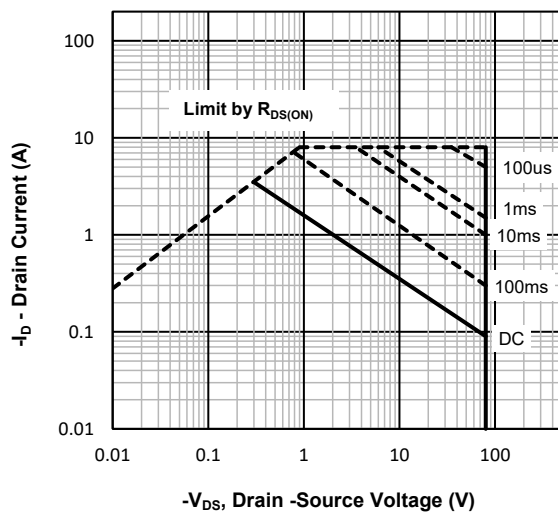


Fig5. Maximum Safe Operating Area

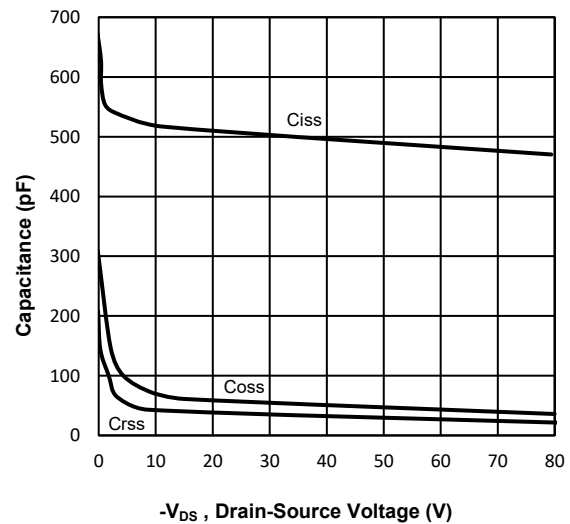
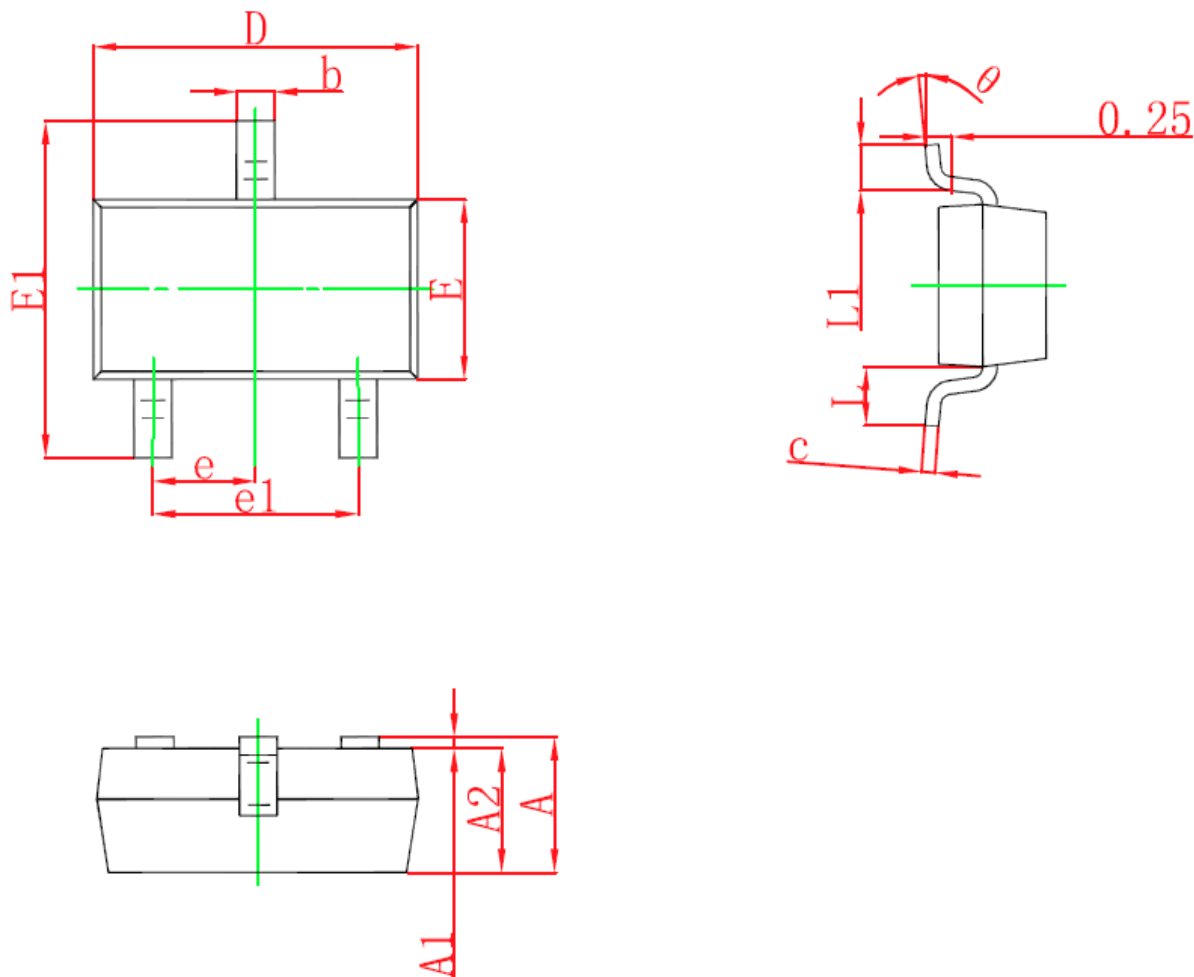


Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOT-23 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°